ISD15100 Series

Multi-Message Record/Playback Devices with Digital Audio Interface

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1 GENERAL DESCRIPTION

The ISD15100 series is a multi-message ChipCorder® featuring digital compression, comprehensive memory management, flash storage, and integrated analog/digital audio signal paths. The message management feature is designed to make message recording simple and address-free as well as make code development easier for playback-only applications. This family utilizes flash memory to provide non-volatile audio record/playback with durations up to 32 minutes for a single-chip solution. Unlike other ChipCorder series, the ISD15100 series provides an I²S digital audio interface, faster digital recording, higher sampling frequency, and a signal path with SNR equivalent to 12bit resolution.

The ISD15100 series can take digital audio data via I²S or SPI interface. When I²S input is selected, it will replace the analog audio inputs and will support sample rates of 32, 44.1 or 48 kHz depending upon clock configuration. When SPI interface is chosen, the sample rate of the audio data sent must be one of the ISD15100 series supported sample rates.

The ISD15100 series has built-in analog audio inputs, analog audio line driver, and speaker driver output. The two analog audio inputs to the device are: (1) AUXIN has a fixed gain configured by SPI command, and (2) ANAIN/ANAOUT has a fixed gain amplifier with the gain set by two external resistors. ANAIN/ANAOUT can also be used as a microphone differential input (ANAIN/ANAOUT becomes MIC+/MIC-) in conjunction with an automatic gain control (AGC) circuit configured by SPI command. Analog outputs are available in three forms: (1) AUXOUT is a single-ended voltage output; (2) AUDOUT can be configured as either a single-ended voltage output or a single-ended current output; (3) BTL (bridge-tied-load) is a differential voltage output.

2 FEATURES

- Fast Digital Programming
 - Programming rate can go up to 1Mbits/second mainly limited by the flash memory write rate.
- Duration
 - 2 to 32 minutes based on 8kHz/4bit ADPCM
- Message Management
 - Perform address-free recording: The ISD151xx allocates memory for new recording requests and upon completion, returns a start address to the host via SPI interface
 - Store pre-recorded audio (Voice Prompts) using high quality digital compression
 - Use a simple index based command for playback
 - Execute pre-programmed macro scripts (Voice Macros) designed to control the configuration of the device and play back Voice Prompts sequences and message recordings.

Sample Rate

- Seven record and playback sampling frequencies are available for a given master sample rate. For example, the record and playback sampling frequencies of 4, 5.3, 6.4, 8, 12.8, 16 and 32kHz* are available when the device is clocked at a 32kHz master sample rate.
 (* 32kHz sample rate is available but subject to flash memory write time.)
- For I²S operation, 32, 44.1 and 48kHz master sample rates are available with record and playback sampling frequencies scaling accordingly.
- Compression Algorithms
 - For recording
 - ADPCM: 2, 3, 4 or 5 bits per sample
 - µ-Law: 6, 7 or 8 bits per sample
 - Differential µ-Law: 6, 7 or 8 bits per sample
 - PCM: 8, 10 or 12 bits per sample. Each sampled value is stored as a code, offering no compression but preserving maximum resolution

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- o For Pre-Recorded Voice Prompts
 - μ-Law: 6, 7 or 8 bits per sample
 - Differential μ-Law: 6, 7 or 8 bits per sample
 - PCM: 8, 10 or 12 bits per sample
 - Enhanced ADPCM: 2, 3, 4 or 5 bits per sample
 - Variable-bit-rate optimized compression. This allows best possible compression given a metric of SNR and background noise levels.

Oscillator

- Internal oscillator with internal reference: 2.048 MHz
- o Internal oscillator with external resistor: 2.048 MHz when Rosc is 80k-ohm
- o External crystal or clock input
- o I²S bit clock input
- Crystals and resonators support standard audio sampling rates of 2.048, 4.096, 8.192, 12.288 and11.2896MHz

Inputs

- AUXIN: Analog input with 2-bit gain control configured by SPI command
- o ANAIN/ANAOUT:
 - Analog input with the gain set by two external resistors from ANAOUT to ANAIN, or
 - Microphone differential input (ANAIN/ANAOUT becomes MIC+/MIC-)
- o Digital AGC:
 - Automatic gain control of digitized data from the analog input

Outputs

- \circ PWM: Class D speaker driver to direct drive an 8Ω speaker or buzzer
- AUDOUT: configurable as a current or voltage single-ended line driver
- AUXOUT: a single-ended voltage output
- BTL: a differential voltage output

I/Os

- SPI interface: MISO, MOSI, SCLK, SSB for commands and digital audio data
- o I²S interface: I²S CLK, I²S WS, I²S SDI, I²S SDO for digital audio data
- o 8 GPIO pins (4 of the 8 GPIO pins share with I²S).
- Three 8-bit Volume Control set by SPI command for flexible mixing
 - O VOLA: volume control for the digital audio data from I²S or analog inputs
 - VOLB: volume control for the digital audio data from decompression block or SPI

- 4 -

- VOLC: master volume control for PWM, AUDOUT, AUXOUT and I²S outputs
- Operating Voltage: 2.7-3.6V
- Standby Current: 1uA typical
- Package: Pb-free 48L-LQFP
- Temperature Options:
 - o Industrial: -40°C to 85°C

3 BLOCK DIAGRAM

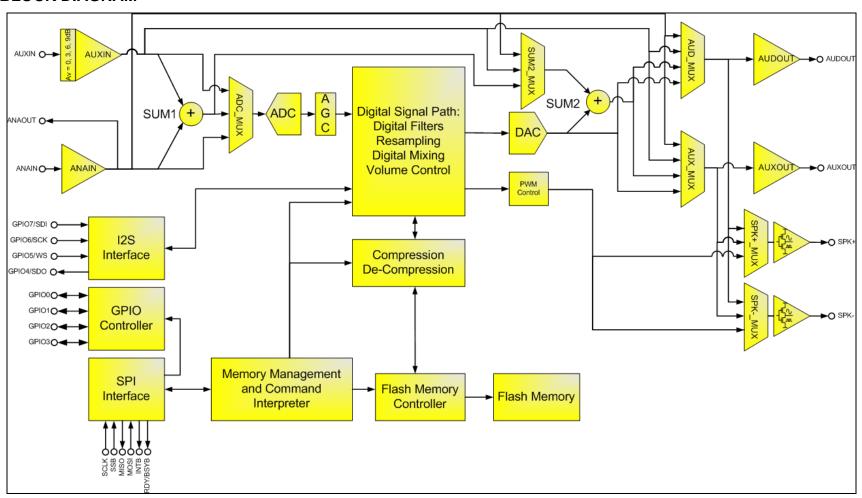


Figure 3-1 ISD15100 Series Block Diagram, ANAIN Selected

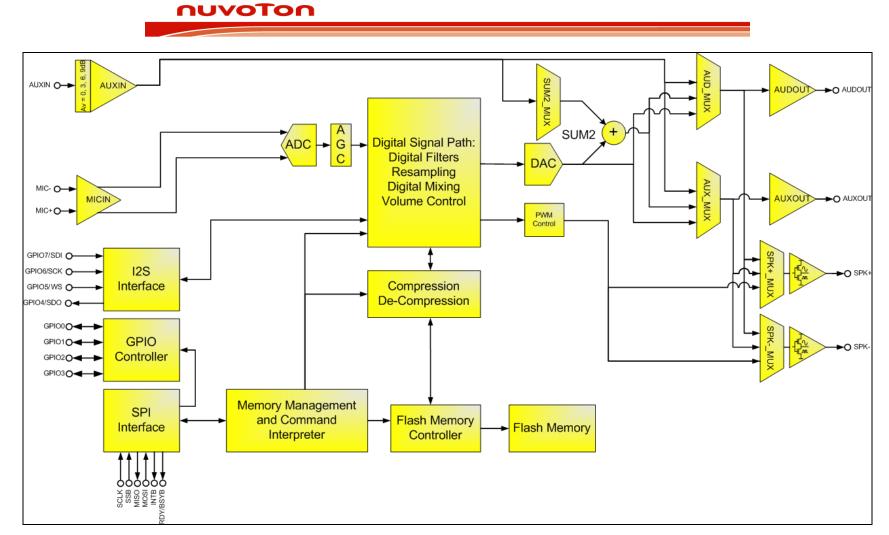


Figure 3-2 ISD15100 Series Block Diagram, MICIN Selected

4 PINOUT CONFIGURATION

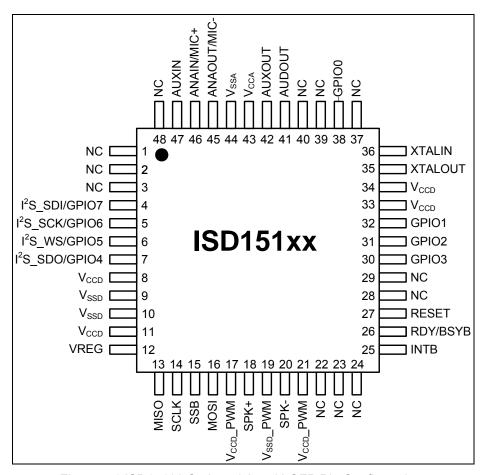


Figure 5-1 ISD15100 Series 48-Lead LQFP Pin Configuration.



5 PIN DESCRIPTION

Pin Number	Pin Name	I/O	Function
1	NC		This pin should be left unconnected.
2	NC		This pin should be left unconnected.
3	NC		This pin should be left unconnected.
4	I ² S_SDI/ GPIO7	I	Serial Data Input of the I ² S interface (If I2S is not used, this pin should be grounded). Or, can be configured as a GPIO pin.
5	I ² S_SCK/ GPIO6	I/O	Clock input in slave mode or clock output in master mode. This pin can be configured as an external clock buffer if I ² S is not used (If I2S is not used, this pin should be grounded). Or, can be configured as a GPIO pin.
6	I ² S_WS/ GPIO5	I/O	Word Select (WS) input in slave mode or WS output in master mode (If I2S is not used, this pin should be grounded). Or, can be configured as a GPIO pin.
7	I ² S_SDO/ GPIO4	Ο	Serial Data Output of the I ² S Interface (If I2S is not used, this pin should be left unconnected). Or, can be configured as a GPIO pin.
8	V _{CCD}	I	Digital power supply.
9	V_{SSD}	I	Digital Ground.
10	V_{SSD}	I	Digital Ground.
11	V _{CCD}	I	Digital power supply.
12	VREG	0	A 1.8V regulator to supply the internal logic. A 0.1uF capacitor should be connected to this pin for supply decoupling and stability.
13	MISO	0	Master-In-Slave-Out. Serial output from the ISD151xx to the host. This pin is in tri-state when SSB=1.
14	SCLK	I	Serial Clock input to the ISD151xx from the host.
15	SSB	I	Slave Select input to the ISD151xx from the host. When SSB is low device is selected and responds to commands on the SPI interface.
16	MOSI	I	Master-Out-Slave-In. Serial input to the ISD151xx from the host.
17	V _{CCD} PWM	I	Digital Power for the PWM Driver.



Pin Number	Pin Name	I/O	Function
18	SPK+	0	PWM driver positive output. This SPK+ output, together with SPK- pin, provide a differential output to drive 8Ω speaker or buzzer. During power down this pin is in tri-state. Or, can be configured as BTL which, together with SPK- pin, provide a differential voltage output. Or, can independently switch to AUDOUT or AUXOUT.
19	V _{SSD} _PWM	I	Digital Ground for the PWM Driver.
20	SPK-	0	PWM driver negative output. This SPK- output, together with SPK+ pin, provides a differential output to drive 8Ω speaker or buzzer. During power down this pin is tri-state. Or, can be configured as BTL which, together with SPK+ pin, provide a differential voltage output. Or, can independently switch to AUDOUT or AUXOUT.
21	V _{CCD} _PWM	I	Digital Power for the PWM Driver.
22	NC		This pin should be left unconnected.
23	NC		This pin should be left unconnected.
24	NC		This pin should be left unconnected.
25	INTB	0	Active low interrupt request pin. This pin is an open-drain output.
26	RDY/BSYB	0	An output pin to report the status of data transfer on the SPI interface. "High" indicates that ISD151xx is ready to accept new SPI commands or data.
27	RESET	I	Applying power to this pin will reset the chip. (A high pulse of 50ms or more will reset the chip.)
28	NC		This pin should be left unconnected.
29	NC		This pin should be left unconnected.
30	GPIO3	I/O	GPIO
31	GPIO2	I/O	GPIO
32	GPIO1	I/O	GPIO
33	V _{CCD}	ı	Digital power supply pin.
34	V _{CCD}	I	Digital power supply pin.
35	XTALOUT	0	Crystal interface output pin.
36	XTALIN	I	The CLK_CFG register determines one of the following three configurations: (1) A crystal or resonator connected between the XTALOUT and XTALIN pins. (2) A resistor connected to GND as a reference current to the internal oscillator and left the XTALOUT unconnected. (3) An external clock input to the device and left the XTALOUT unconnected.



Pin Number	Pin Name	I/O	Function
37	NC		This pin should be left unconnected.
38	GPIO0	I/O	GPIO
39	NC		This pin should be left unconnected.
40	NC		This pin should be left unconnected.
41	AUDOUT	Ο	Audio Out. This pin can be either a voltage output or a current output configured by the internal registers via SPI command. If AUDOUT is not used, this pin should be left unconnected.
42	AUXOUT	0	Aux Out. This pin is an analog voltage output. If AUXOUT is not used, this pin should be left unconnected.
43	V _{CCA}	I	Analog power supply pin.
44	V_{SSA}	I	Analog ground pin.
45	ANAOUT/ MIC-	0	Variable gain analog output with the gain set by feedback resistance to ANAIN. Or, can be configured as MIC- which, together with MIC+, provides a microphone differential input. If ANAIN/ANAOUT is not used, this pin should be left unconnected.
46	ANAIN/ MIC+	I	Variable gain analog input. Or, can be configured as MIC+ which, together with MIC-, provides a microphone differential input. If ANAIN/ANAOUT is not used, this pin should be left unconnected.
47	AUXIN	I	Auxiliary input with the gain set by SPI command If AUXIN is not used, this pin should be left unconnected.
48	NC		This pin should be left unconnected.



6 ELECTRICAL CHARACTERISTICS

6.1 OPERATING CONDITIONS

OPERATING CONDITIONS (INDUSTRIAL PACKAGED PARTS)

CONDITIONS	VALUES
Operating temperature range (Case temperature)	-40°C to +85°C
Supply voltage (V _{DD}) [1]	+2.7V to +3.6V
Ground voltage (V _{SS}) [2]	0V
Input voltage (V _{DD}) [1]	0V to 3.6V
Voltage applied to any pins	$(V_{SS} -0.3V)$ to $(V_{DD} +0.3V)$

NOTES: $[1] V_{DD} = V_{CCA} = V_{CCD} = V_{CCPWM}$ $[2] V_{SS} = V_{SSA} = V_{SSD} = V_{SSPWM}$

6.2 DC PARAMETERS

PARAMETER	SYMBOL	MIN	TYP [1]	MAX	UNITS	CONDITIONS
Supply Voltage	V_{DD}	2.7		3.6	V	
Input Low Voltage	V_{IL}	V _{SS} -0.3		$0.3xV_{DD}$	V	
Input High Voltage	V_{IH}	$0.7xV_{DD}$		V_{DD}	V	
Output Low Voltage	V _{OL}	V _{SS} -0.3		$0.3xV_{DD}$	V	I _{OL} = 3μA
Output High Voltage	V_{OH}	$0.7xV_{DD}$		V_{DD}	V	I _{OH} = -10μA
INTB Output Low Voltage	V_{OH1}			0.4	V	
Record Current	I _{DD_Record}			40	mA	V _{DD} = 3.6V, No load, Sampling freq = 16 kHz
Playback Current	I _{DD_Playback}			30	mA	
Standby Current	I _{SB}		1	10	μA	V _{DD} = 3.6V
Input Leakage Current	I _{IL}			±1	μΑ	Force V _{DD}

Notes: [1] Conditions V_{DD}=3V, T_A=25°C unless otherwise stated

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6.3 **AC PARAMETERS**

6.3.1 **Internal Oscillator**

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	CONDITIONS
Internal Oscillator with internal reference	F _{INT}	-10%	2.048 MHz	+10 %	MHz	Vdd = 3V. At room temperature
Internal Oscillator with external resistor [1]	F _{Ext}	-5%	2.048 MHz	+5%	MHz	With 1% precision resistor, 80k-ohm. Vdd = 3V. At room temperature

Notes:

6.3.2 Inputs

ANAIN & MICIN

PARAMETER	SYMBOL	MIN	TYP [1]	MAX	UNITS	CONDITIONS			
ANAIN Input Voltage	V _{ANAIN}		10-1000		mV	Peak-to-Peak[2]			
ANAIN Feed Back Resistance	R _{ANA(FB)}	40		100	ΚΩ				
MICIN Input Voltage	V _{MICIN}		5-500		mV	Peak-to-Peak ^[2]			

Notes:

AUXIN

PARAMETER	SYMBOL	MIN	TYP ^[1]	MAX	UNITS	CONDITIONS
AUXIN Input Voltage	V _{AUXIN}		1000		mV	Peak-to-Peak ^[2]
Gain from AUXIN to AUXOUT/ANAOUT	A _{AUXIN GAIN}		0 to 9		dB	4 Gain Steps of 3db each
AUXIN Gain Accuracy	A _{AUXIN (GA)}	-0.5		+0.5	dB	
AUXIN Input Resistance	R _{AUXIN}		20-40		ΚΩ	Depending on AUXIN Gain Setting

Notes:

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^[1]Characterization data shows that frequency deviation is +/- 5% across temperature and voltage ranges.

 $^{^{[1]}}$ Conditions V_{DD} =3V, T_{AB} =25°C unless otherwise stated

^[2] Depends on Gain Setting

^[1] Conditions V_{DD} =3V, T_A =25°C unless otherwise stated. ^[2] With 0db Gain setting.



6.3.3 Outputs

AUXOUT

PARAMETER	SYMBOL	MIN	TYP ^[1]	MAX	UNITS	CONDITIONS
SINAD, AUXIN to AUXOUT	SINAD _{AUXIN_AUXOUT}		80		dB	Load 5K ^{[2][3]}
SINAD, ANAIN to AUXOUT	SINAD _{ANAIN_AUXOUT}		80		dB	Load 5K ^{[2][3]}
PSRR	PSRR _{AUXOUT}		-40		dB	[4]
DC Bias	V _{BIAS_AUXOUT}			1.2	V	
Minimum Load Impedance	R _{L(AUXOUT)}	5			ΚΩ	
Maximum Load Capacitance	$C_{L(AUXOUT)}$			0.1	nF	

Notes:

AUDOUT

PARAMETER	SYMBOL	MIN	TYP ^[1]	MAX	UNITS	CONDITIONS
SINAD, AUXIN to AUDOUT ^[5]	SINAD _{AUXIN_AUDOUT}		80		dB	Load 5K ^{[2][3]}
SINAD, ANAIN to AUDOUT ^[5]	SINAD _{ANAIN_AUDOUT}		80		dB	Load 5K ^{[2][3]}
PSRR ^[5]	PSRR _{AUDOUT}		-40		dB	[4]
DC Bias ^[5]	V _{BIAS_AUDOUT}			1.2	V	
Minimum Load Impedance ^[5]	$R_{L(AUDOUT)}$	5			ΚΩ	
Maximum Load Capacitance ^[5]	$C_{L(AUDOUT)}$			0.1	nF	
Output Current [6]	I _{AUDOUT}	0	3	6	mA	[2][6]

Notes:

^[1] Conditions V_{DD} =3V, T_A =25°C unless otherwise stated. [2] 1 Vpp 1KHz signal applied at AUXIN/ANAIN with 0db Gain setting. [3] All measurements are C-message weighted. [4] Measured with 1KHz, 100 mVpp sine wave applied to V_{CCA} pins.

 $^{^{[1]}}$ Conditions $V_{\rm cc}$ =3V, T_A =25°C unless otherwise stated. $^{[2]}$ 1 Vpp 1KHz signal applied at AUXIN/ANAIN with 0db Gain setting.

^[3] All measurements are C-message weighted.

 $^{^{[4]}}$ Measured with 1Khz, 100 mVpp sine wave applied to V_{CCA} pins.

^[5] Configured as AUDOUT(Voltage Output).

^[6] Configured as AUDOUT(Current Output).



SPEAKER OUTPUTS

PARAMETER	SYMBOL	MIN	TYP ^[1]	MAX	UNITS	CONDITIONS
SNR, AUXIN to SPK+/SPK-	SNR _{AUXIN_SPK}		60		dB	Load 150Ω ^{[2][3]}
SNR, ANAIN to SPK+/SPK-	SNR _{ANAIN_SPK}		60		dB	Load 150Ω ^{[2][3]}
Output Power	P _{OUT_SPK} VCC=3.0			360	mW	Load 8Ω ^[2]
THD, AUXIN to SPK+/SPK-	THD %		<1%			Load 8Ω ^[2]
Minimum Load Impedance	R _{L(SPK)}	4	8		Ω	

Notes:

6.3.4 **SPI Timing**

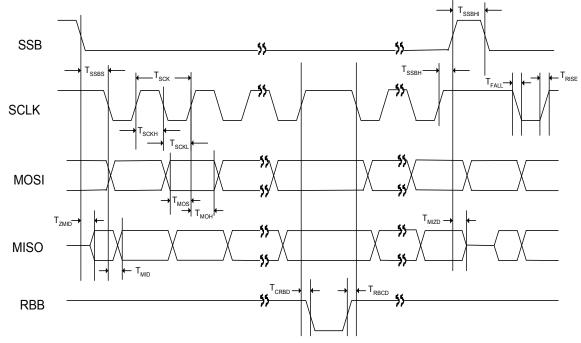


Figure 7-1 SPI Timing

Conditions V_{cc} =3V, T_A =25°C unless otherwise stated. ^[2] 1 Vpp 1KHz signal applied at AUXIN/ANAIN with 0db Gain setting. ^[3] All measurements are C-message weighted.



SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNIT
T _{SCK}	SCLK Cycle Time				ns
T _{SCKH}	SCLK High Pulse Width	25			ns
T _{SCKL}	SCLK Low Pulse Width	25			ns
T _{RISE}	Rise Time for All Digital Signals			10	ns
T _{FALL}	Fall Time for All Digital Signals			10	ns
T _{SSBS}	SSB Falling Edge to 1 st SCLK Falling Edge Setup Time	30			ns
T _{SSBH}	Last SCLK Rising Edge to SSB Rising Edge Hold Time	30 ns		50us	
T _{SSBHI}	SSB High Time between SSB Lows				ns
T _{MOS}	MOSI to SCLK Rising Edge Setup Time				ns
Тмон	SCLK Rising Edge to MOSI Hold Time				ns
T_{ZMID}	Delay Time from SSB Falling Edge to MISO Active			12	ns
T _{MIZD}	Delay Time from SSB Rising Edge to MISO Tri-state			12	ns
T _{MID}	Delay Time from SCLK Falling Edge to MISO			12	ns
T _{CRBD}	Delay Time from SCLK Rising Edge to RBB Falling Edge			12	ns
T _{RBCD}	Delay Time from RBB Rising Edge to SCLK Falling Edge	0			ns



6.3.5 I²S Timing

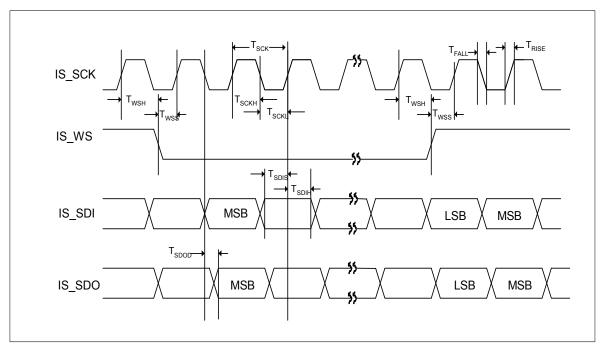


Figure 7-2 I²S Timing

SYMBOL	DESCRIPTION		TYP	MAX	UNIT
T _{SCK}	IS_SCK Cycle Time	60			ns
T _{SCKH}	IS_SCK High Pulse Width	25			ns
T _{SCKL}	IS_SCK Low Pulse Width	25			ns
T _{RISE}	Rise Time for All Digital Signals			10	ns
T _{FALL}	Fall Time for All Digital Signals			10	ns
T _{WSS}	WS to IS_SCK Rising Edge Setup Time	20			ns
T _{WSH}	IS_SCK Rising Edge to IS_WS Hold Time 20				ns
T _{SDIS}	IS_SDI to IS_SCK Rising Edge Setup Time				ns
T _{SDIH}	IS_SCK Rising Edge to IS_SDI Hold Time	15			ns
T _{SDOD}	Delay Time from IS_SCLK Falling Edge to IS_SDO			12	ns



7 APPLICATION DIAGRAM

The following applications example is for references only. It makes no representation or warranty that such applications shall be suitable for the use specified. Each design has to be optimized in its own system for the best performance on voice quality, current consumption, functionalities and etc.

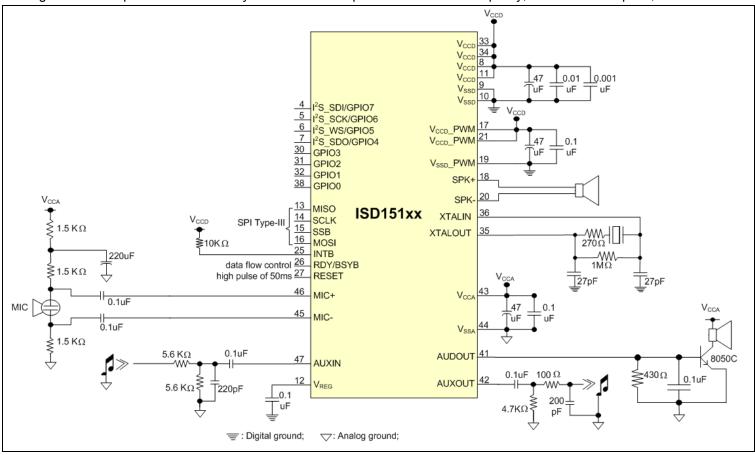
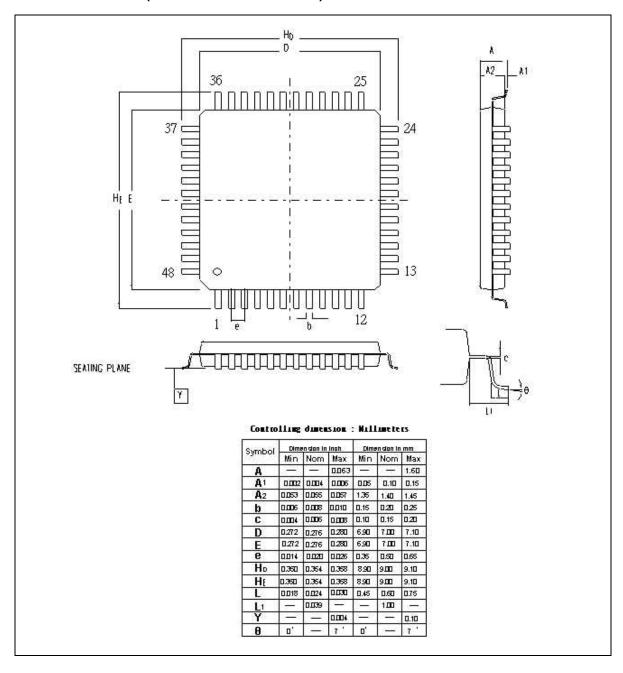


Figure 7-1 ISD15100 Series Application Diagram

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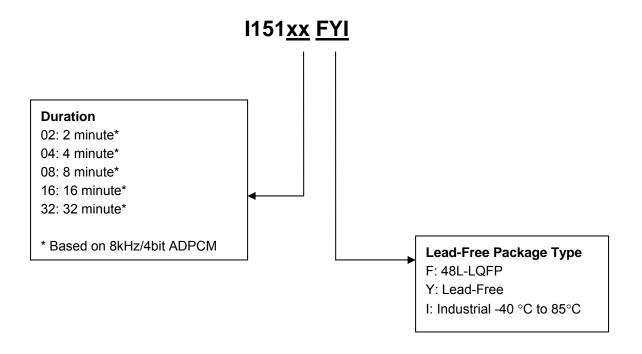
8 PACKAGE SPECIFICATION

8.1 48 LEAD LQFP(7x7x1.4MM FOOTPRINT 2.0MM)





9 ORDERING INFORMATION





10 REVISION HISTORY

Version	Date	Description	
0.71	May 28, 2008	Initial release.	
		Reset pulse: 50ms.	
		 Add a 270-ohm resistor between XTALOUT and crystal. 	
		Update spec of internal oscillator.	
		Industrial temp.	
0.75	Sep 10, 2008	Update:	
		SPI timing: T _{SSBH} maximum 50us.	
		MICIN input signal: 500mV	
		Revise Block Diagram; add BTL block.	
		Revise Application Diagram.	
Nov 24, 2008		Remove "preliminary" watermark.	
		Change to Nuvoton logo.	



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